AN EFFICIENT DESIGN OF LATCHES FOR MULTI-CLOCK MULTI-**MICROCONTROLLER SYSTEM ON CHIP FOR BUS SYNCHRONIZATION**

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Abstract

Speed is a very interesting feature of present time systems either it is electronic or mechanical. From a long time system designers are trying to speed up the system. There are many constraints for the designers as only speed of the system is not required cost, power, size and complexity should not increase up to a certain limit. Now in case of microprocessor/microcontroller speed is the main consideration. No one wants the lower speed microprocessor/microcontroller. Any embedded system speed is dependent on the speed of the processor. Early time processor designers were followed a concept of increasing the number of data lines. In the processor design first four bit microprocessor was developed after that eight, sixteen, thirty two and so on. But soon this concept was saturated as the number of lines increases up to a large extent. The complexity and power dissipation increases due to the increase in the capacitance by these lines. In the same way the concept of pipelining was also saturated after a certain design complexity level. So designers move to a new architecture that is the multi-core architecture. In multi core architecture similar microcontrollers are connected in parallel. These microcontrollers are connected to a common shared bus. So the speed of the multi-microcontroller architecture depends on speed of the interconnection network. This interconnection network is nothing but network-on-chip (NoC). So there is a need of synchronization of the buses of microcontrollers to common shared bus by means of arbitration technique. To synchronize the buses we need tri state buffers/latches.

In this paper, we have explored several critical aspects in the design of the latches. Latches are required for the bus synchronization of multi-microcontroller system on programmable chip (MMSoPC).

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Index Terms: MMSoPC, NoC.

1. INTRODUCTION

Current time embedded systems are increasingly based on Multi-Microcontroller System-on-Programmable-Chip (MMSoPC). These MMSoPCs typically contain multiple storage elements (SEs), networks (NEs), I/O components, heterogeneous and number of programmable а microcontrollers for flexible application support as well as dedicated processing elements (PEs) for achieving high performance and power goals MMSoPCs have been widely used in today's high performance embedded systems, such as network processors (NP), Mobile Phones (MP) and parallel media processors (PMP). They combine the advantages of data processing parallelism of multiprocessors and the high level integration of system-on-chip (SoC). Driven by the advancement in semiconductor technology, future SoCs [2, 5] will continue to accelerate in system's complexity and capacity. SoCs in the next decade are expected to integrate hundreds, or even more of, processing elements (PEs) and/or storage elements (SEs) on a single chip.

But low cost embedded systems are limited to the microcontroller performance. To improve the performance of low cost embedded system we have to develop Multi-Microcontroller System-on-Chip. So we are migrating number of low cost Microcontrollers to a single chip. To achieve it we can use the generic architecture of MMSoPC.





In order to cope with the design complexity of such systems in a time-efficient way, the abstraction level of the design

process has in recent years been raised towards the system level. Design Space Exploration (DSE) is a key ingredient of such system-level design, during which a wide range of design choices are explored, especially during the early design stages [14]. Therefore, such early design choices heavily influence the success or failure of the final product, and we can avoid wasting time and effort in further design steps without the possibility of meeting design requirements because of an inappropriate system architecture design.

2. GENERIC ARCHITECTURE OF MULTI-

MICROCONTROLLER SYSTEM

Theoretical models of parallel embedded systems are abstracted from the physical models. These models are often used by algorithm designer and VLSI device/Chip developers. The ideal model provides a convenient framework for developing parallel algorithms/hardware without worry about the implementation details or physical constraints [10]. A generic architecture of multimicrocontroller system is shown in fig. 1. There are number of microcontrollers are connected in parallel to a shared bus interface. Input/output sub systems and memory segment are also connected to this shared bus.

3. DESIGN (NoC) MODEL OF MULTI-MICROCONTROLLER SYSTEM

To synchronize the local system buses to the global system buses NoC is inserted between the global system bus and local system buses. A clear view of the system with NoC is shown in fig. 2. The operating speed i.e. the switching capability should match with the four microcontrollers. As in our case the number of microcontrollers is four.



AB: Address bus, DB: Data Bus, CB&SB: Control Bus & Status Bus

Fig -2: Design Model of Multi-Microcontroller System

Networks-on-Chip (NoCs) were proposed as the solution to

shared bus scalability issues, emerging as the new parading for designing scalable communication infrastructures in SoCs. The main advantage of a NoC over a shared bus is its capability to reduce design costs while providing highperformance communications. In NoC, а each microcontroller is connected by a Network Interface (NI) to a network link [3]. Those links are point-to-point data lines connected with other links via switches. A link can connect a switch with another switch or with a NI, in such a way that there exists direct or indirect connection between any two cores. Due to the similarities between interconnection networks and NoCs, it is possible to borrow concepts and techniques from the former and apply them to NoCs. Even so, most of the techniques developed for interconnection networks cannot be directly applied in NoCs, while other ones would be completely unaffordable using current technologies [15]. The reason for this lies in the restrictions imposed by each environment. For example, while in interconnection networks buffers are a relatively abundant and affordable resource; in NoCs they are scarce and expensive, with high area requirements and power consumption, which hinders even more their use in NoCs. On the contrary, links are an expensive resource in interconnection networks that must be used with austerity, while in NoCs links are more abundant. Additionally, the total area available and the tolerable power consumption budget of a SoC are very limited. An ideal NoC must meet the communications needs of the design while minimizing power and area consumption. This latter fact implies that the switches should be as fast, small and power-efficient as possible, which hinders even more the application of interconnection solutions in NoC designs. The architecture of each NoC component directly or indirectly affects all kinds of design parameters, like maximum operating frequency, buffering requirements, etc. The compilation of architectures of the components that compose the network is referred as network architecture.

4. RELATED WORK AND DESIGN ANALYSIS

There are four latches for address bus, data bus, control bus and status bus. Only address bus is unidirectional and rest is bi-directional. So the complexity of address bus is less as compare to the others. The modeling and designing of intelligence latches are done. The latches shown in fig.6 has been successfully simulated and synthesized on Zynq-7000 by Xilinx Vivado 2013.4.

4.1 RTL Modeling of Latch for Address Bus Latch_Address:

Port (Clk_in : in STD_LOGIC; LAdd_in : in STD_LOGIC_VECTOR (15 downto 0); TriStateBuffer_En : in STD_LOGIC; LAdd_Out : out STD_LOGIC_VECTOR (15 downto 0)); begin if (Clk_in'event and Clk_in = '1') then Temp_Add <= LAdd_in; end if; end process; CTRL_BUFFER: process (TriStateBuffer_En, Temp_Add) begin if (TriStateBuffer_En = '1') then LAdd_Out <= Temp_Add; end process; 4.2 RTL Modeling of Latch for Data Bus Latch_Data: Port (Clk in : in STD LOGIC; TriStateBuffer En : in STD LOGIC; Latch DB DIR :in STD LOGIC; LData_In_LGSB : in STD_LOGIC_VECTOR (7 downto 0); LData_Out_LGSB : out STD_LOGIC_VECTOR (7 downto 0);LData_In_GSBL : in STD_LOGIC_VECTOR (7 downto 0); LData_Out_GSBL : out STD_LOGIC_VECTOR (7 downto 0)); begin ____ _____ end process; CTRL_BUFFER1: process (TriStateBuffer_En, Temp_Data, Latch DB DIR) begin if (TriStateBuffer_En = '1' and Latch_DB_DIR = '0') then LData Out LGSB <= Temp Data; --------end process; CTRL_BUFFER2: process (TriStateBuffer_En, Temp_Data, Latch_DB_DIR) begin if (TriStateBuffer_En = '1' and Latch_DB_DIR ='1') then LData Out GSBL <= Temp Data; _____ end process; 4.3 RTL Modeling of Latch for Control Bus Latch_control: Port (Clk_in : in STD_LOGIC; Latch CB DIR :in STD LOGIC; TriStateBuffer_En : in STD_LOGIC; LCtrl_In_LGSB : in STD_LOGIC_VECTOR (5 downto 0); LCtrl_Out_LGSB : out STD_LOGIC_VECTOR (5 downto 0);

LCtrl_In_GSBL : in STD_LOGIC_VECTOR (5 downto 0);

LCtrl_Out_GSBL : out STD_LOGIC_VECTOR (5 downto 0)); begin _____ _____ ____ end process: CTRL BUFFER1: process(TriStateBuffer En, Temp Ctrl, Latch_CB_DIR) begin if (TriStateBuffer En = '1' and Latch CB DIR = '0') then LCtrl_Out_LGSB <= Temp_Ctrl; ____ end process; CTRL_BUFFER2: process(TriStateBuffer_En, Temp_Ctrl, Latch_CB_DIR) begin if (TriStateBuffer_En = '1' and Latch_CB_DIR ='1') then LCtrl Out GSBL <= Temp Ctrl; _____ end process; 4.4 RTL Modeling of Latch for Status Bus Latch Status: Port (Clk_in : in STD_LOGIC; Latch_SB_DIR :in STD_LOGIC; TriStateBuffer En : in STD LOGIC; LStatus_In_LGSB : in STD_LOGIC_VECTOR (1 downto 0);LStatus_Out_LGSB : out STD_LOGIC_VECTOR (1 downto 0); LStatus_In_GSBL : in STD_LOGIC_VECTOR (1 downto 0):LStatus_Out_GSBL : out STD_LOGIC_VECTOR (1 downto 0)); begin ____ ____ ____ end process; CTRL_BUFFER1: process(TriStateBuffer_En, Temp_Status, Latch_SB_DIR) begin if (TriStateBuffer En = '1' and Latch SB DIR = '0')

end process;

CTRL_BUFFER2: process(TriStateBuffer_En, Temp_Status, Latch_SB_DIR)

begin

end process;

5. LATCH BOX

To reduce the complexity of the system by the above discussed latches. We have introduced a component, known as latch box. In latch box all latches are integrated to form a component which is later used in the multi-microcontroller system.

RTL Modelling of Latch Box

Port (

LBx_Clk_in : in STD_LOGIC;

LBx_TriStateBuffer_En : in STD_LOGIC;

LBx_LAdd_in : in STD_LOGIC_VECTOR (15 downto 0); LBx_LAdd_Out : out STD_LOGIC_VECTOR (15 downto 0);

LBx_LData_In_LGSB : in STD_LOGIC_VECTOR (7 downto 0);

LBx_LData_Out_LGSB : out STD_LOGIC_VECTOR (7 downto 0);

LBx_LData_In_GSBL : in STD_LOGIC_VECTOR (7 downto 0);



Fig-3: RTL Schematic of Latch Box

LBx_LData_Out_GSBL : out STD_LOGIC_VECTOR (7 downto 0); LBx_Latch_DB_DIR : in STD_LOGIC; LBx_LStatus_In_LGSB : in STD_LOGIC_VECTOR (1 downto 0);

LBx_LStatus_Out_LGSB : out STD_LOGIC_VECTOR (1 downto 0); LBx_LStatus_In_GSBL : in STD_LOGIC_VECTOR (1 downto 0); LBx_LStatus_Out_GSBL : out STD_LOGIC_VECTOR (1 downto 0); LBx_Latch_SB_DIR : in STD_LOGIC; LBx_LCtrl_In_LGSB : in STD_LOGIC_VECTOR (5 downto 0); LBx_LCtrl_Out_LGSB : out STD_LOGIC_VECTOR (5

LBx_LCtrl_Out_LGSB : out STD_LOGIC_VECTOR (5 downto 0); LBx_LCtrl_In_GSBL : in STD_LOGIC_VECTOR (5 downto 0);

LBx_LCtrl_Out_GSBL : out STD_LOGIC_VECTOR (5 downto 0);

LBx_Latch_CB_DIR : in STD_LOGIC);

6. RESULTS

6.1 Utilization Graph



Fig -4: Utilization Graph

6.2 Utilization Table

Table -1: Utilization Table

Resource	Estimation	Available	Utilization %
FF	32	106400	1
LUT	11	53200	1
1/0	85	200	43
BUFG	1	32	3

6.3 Behavioral Simulation of Latch Box







Fig-6: RTL Schematic of different latches



6.5 DRC Report



6.6 Implementation Report



6.7 Timing Report

Timing		*
Worst Negative Slack (WNS):	8.607 ns	
Total Negative Slack (TNS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	2	
Setup Hold Pulse Width		
Post-Synthesis Post-Imp	lementation	

6.8 Power Report

Power		*
Total On-Chip Power:	0.134 W	
Junction Temperature:	26.5 °C	
Thermal Margin:	58.5 °C (4.9 W)	
Effective 8JA:	11.5 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Low	
Summary On-Chip		

6.9 Power Summary (Graph)

0%	🗖 Dynamic:	0.014 W	(10%)
	Clocks:	0.001 W	(10%)
	Signals:	0.000 W	(3%)
0%	87% 🔲 Logic:	0.000 W	(0%)
	🔲 I/O;	0.012 W	(87%)
	Device Static:	0.120 W	(90%)
mma	ry On-Chip		

Fig -7: Power Summary

6.10 Implemented Design



Fig -8: Implemented Design

7. CONCLUSIONS

In the above result design of latches namely address, data, control and status for multi microcontroller embedded system on programmable chip is successfully done. Also the designed latches are integrated into a single component i. e. latch box. This latch box with different latches will be used in the multi-microcontroller-system-on-programmable-chip for the synchronization of address bus, data bus, control bus and status bus to the shared bus which is global system bus.

The prototyping & verification has been done using following tools & technology by considering various design constraints:

Software operating environment:

- Operating System: UBUNTU 14.04 LTS
- Hardware Design Software: Vivado 2013.4
- Modeling and Simulation Software: Vivado 2013.4
- Synthesis Software: Vivado 2013.4
- Static Timing Analyzer: Vivado 2013.4
- Power Analyzer: Vivado 2013.4
- Power Estimator: Vivado 2013.4

Hardware Prototyping Environment:

- FPGA Device: Zynq-7000 (Ultra-Fast and Ultra-Low-Power)
- Zynq-7000 FPGA Device Series: xc7z020clg484-1
- Device Technology: 28nm
- Device Category: General Purpose
- Clock Frequency: 50 Hz to 1GHz
- Speed Grade: -1
- No. of Pins: 484
- Operating Voltage: 1.16 V
- Operating Temperature: -20° C to 80° C
- Operating Clock Frequency: 100 MHz

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